Preliminary Amendment National Stage of PCT/JP2005/004138 Attorney Docket No. Q80400

## **AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions and listings of claims in the application:

## **LISTING OF CLAIMS:**

- 1. (original) A gallium nitride-based semiconductor device having a p-type layer that is a gallium nitride (GaN) compound semiconductor layer containing a p-type impurity and exhibiting p-type conduction, wherein the p-type layer comprises a top portion and an inner portion located under the top portion, wherein the inner portion contains the p-type impurity and, in combination therewith, hydrogen and wherein the top portion includes a region containing a Group III element and a Group V element at a non-stoichiometric atomic ratio.
- 2. (original) A gallium nitride-based semiconductor device according to claim 1, wherein the inner portion of the p-type layer has a percent thickness of 40% to 99.9% with respect to a thickness of the p-type layer.
- 3. (currently amended) A gallium nitride-based semiconductor device according to claim 1 or claim 2, wherein the inner portion of the p-type layer has a hydrogen concentration of  $1 \times 10^{18} \text{ cm}^{-3}$  or more and an impurity concentration of  $1 \times 10^{18} \text{ cm}^{-3}$  to  $1.\times 10^{21} \text{ cm}^{-3}$ .
- 4. (currently amended) A gallium nitride-based semiconductor device according to <u>claim</u>

  <u>1</u>-any one of claims 1 to 3, wherein the inner portion has a hydrogen concentration that is equal to, or lower than, an impurity concentration.
- 5. (currently amended) A gallium nitride-based semiconductor device according to <u>claim</u>

  1-any one of claims 1 to 4, wherein the region containing a Group III element and a Group V element at a non-stoichiometric atomic ratio has a thickness of 1 to 10 nm from the top surface of the p-type layer in a depth direction.

2

Preliminary Amendment National Stage of PCT/JP2005/004138 Attorney Docket No. Q80400

- 6. (currently amended) A gallium nitride-based semiconductor device according to <u>claim</u>

  1-any one of claims 1 to 5, wherein the top portion of the p-type layer has a surface having

  Ga deposited thereon.
- 7. (currently amended) A gallium nitride-based semiconductor device according to <u>claim</u>

  1-any one of claims 1 to 6, wherein the p-type layer has a surface having joined thereto a
  gallium nitride semiconductor material containing a Group III element and a Group V
  element at a non-stoichiometric atomic ratio.
- 8. (original) A gallium nitride-based semiconductor device according to claim 7, wherein the gallium nitride semiconductor material is boron phosphide (BP) having a non-stoichiometric atomic ratio.